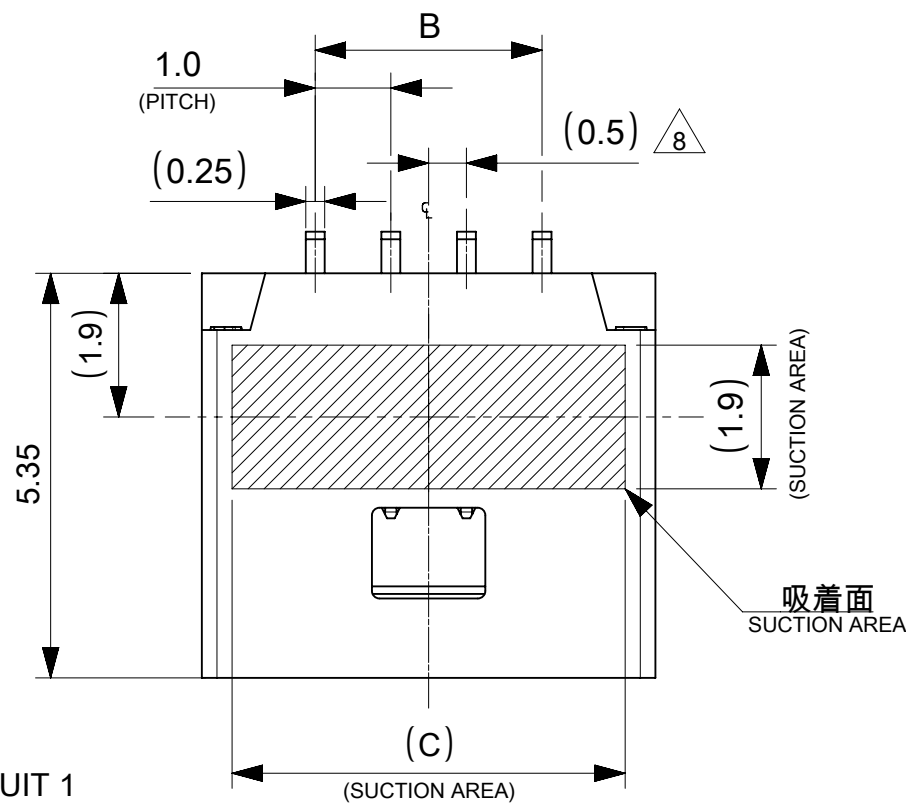
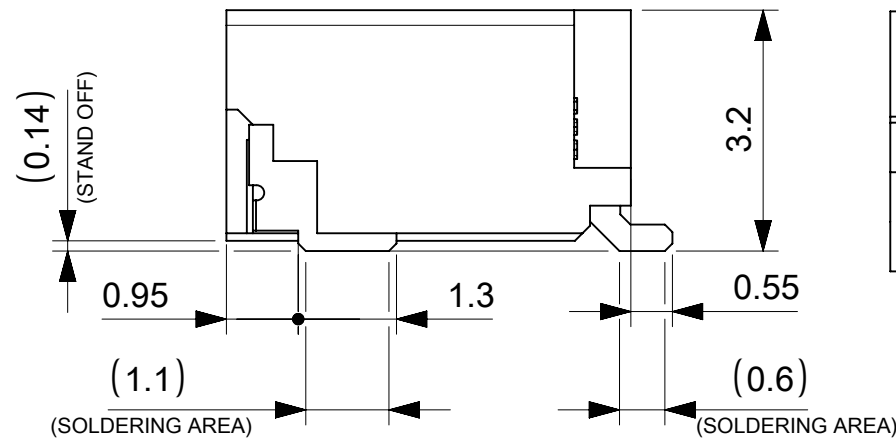
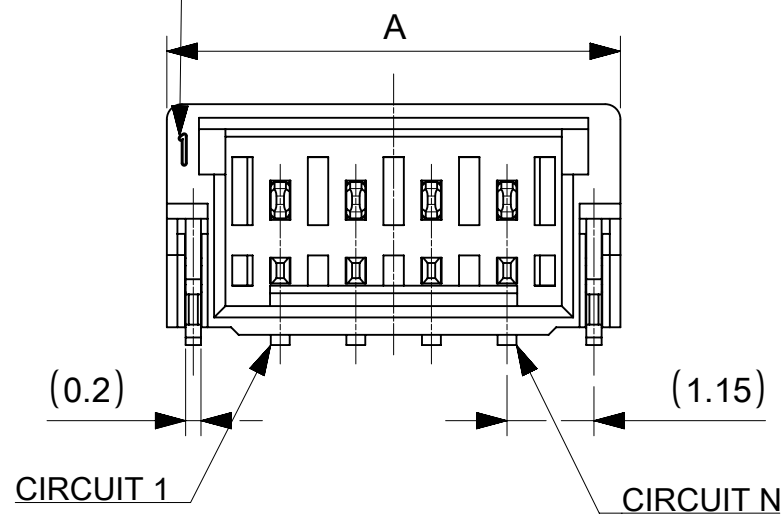


NOTES

1. 本製品は極数によって、ロック形状が変わりますのでご注意願います
THE LOCK SHAPE OF THIS PRODUCT CHANGES ACCORDING TO THE NUMBER OF CIRCUIT.
2~5 CIRCUITS : フリクションロック FRICTION LOCK
6~15 CIRCUITS : インナーポジティブロック INNER POSITIVE LOCK
2. 材料及び仕上げ(めっき仕様) : TABLE 1,2 参照
MATERIAL AND FINISHES : SEE TABLE 1 AND 2
3. 製品仕様書 : 5013300001-PS 000
PRODUCT SPECIFICATION:
4. 梱包形態 : SEE SHEET 4
PACKAGING INFORMATION:
5. 嵌合相手 : 501330 シリーズ
MATES WITH:501330 SERIES
6. アプリケーション仕様書(コネクタ取扱い説明書) : 5013300000-AS 000
APPLICATION SPECIFICATION(CONNECTOR MANUAL):
7. ソルダピン及びネイルの平坦度:0.1 MAX.
SOLDER PIN AND NAIL COPLANARITY: 0.1 MAX.
8. 偶数極に適用
APPLY FOR EVEN CIRCUIT
9. その他金めっき厚品及び錫めっき品は以下の図面をご参照ください
PLEASE REFER TO THE FOLLOWING DRAWING
FOR OTHER GOLD PLATING VERSION AND TIN PLATING VERSION.



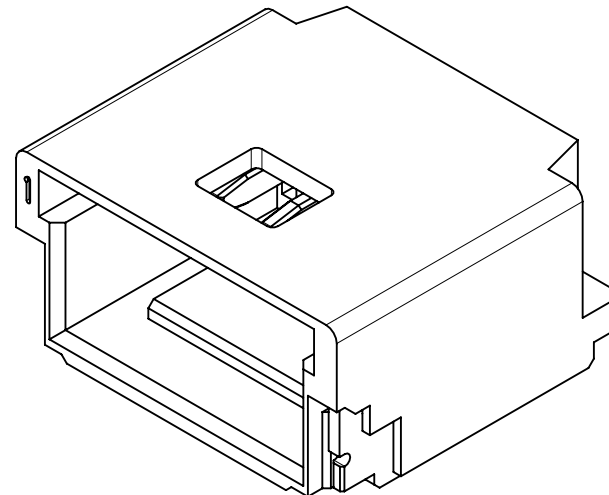
CIRCUIT 1
INDICATOR MARK



PLATING	PLATING THICKNESS [micro-meter MIN.]	SERIES No.	DRAWING No.
TIN	1.0	501568	5015680000-SD PSD 000
GOLD	0.1	202396	2023960000-SD PSD 000
	0.38	203558	2035580000-SD PSD 000

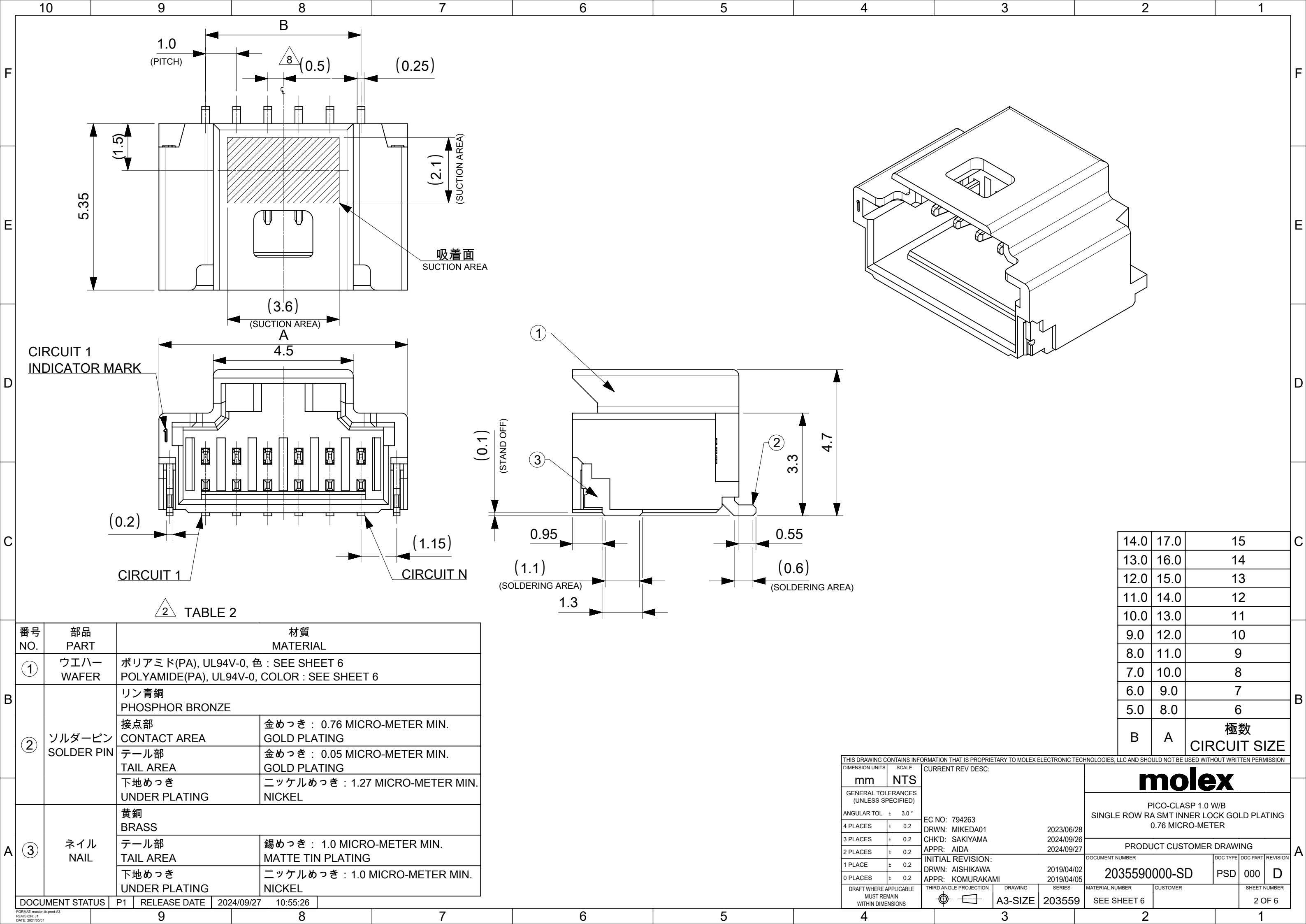
2 TABLE 1

番号 NO.	部品 PART	材質 MATERIAL	
①	ウエハー WAFER	ポリアミド(PA), UL94V-0, 色 : SEE SHEET 6 POLYAMIDE(PA), UL94V-0, COLOR : SEE SHEET 6	
②	ソルダーピン SOLDER PIN	リン青銅 PHOSPHOR BRONZE	
		接点部 CONTACT AREA	金めっき : 0.76 MICRO-METER MIN. GOLD PLATING
		テール部 TAIL AREA	金めっき : 0.05 MICRO-METER MIN. GOLD PLATING
		下地めっき UNDER PLATING	ニッケルめっき : 1.27 MICRO-METER MIN. NICKEL
③	ネイル NAIL	黄銅 BRASS	
		テール部 TAIL AREA	錫めっき : 1.0 MICRO-METER MIN. MATTE TIN PLATING
		下地めっき UNDER PLATING	ニッケルめっき : 1.0 MICRO-METER MIN. NICKEL



6.2	4.0	7.0	5
5.2	3.0	6.0	4
4.2	2.0	5.0	3
3.2	1.0	4.0	2
C	B	A	極數 CIRCUIT SIZE

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
DIMENSION UNITS		SCALE		CURRENT REV DESC:		molex			
mm		NTS							
GENERAL TOLERANCES (UNLESS SPECIFIED)				PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.76 MICRO-METER					
ANGULAR TOL ± 3.0°									
4 PLACES		± 0.2		EC NO: 794263		PRODUCT CUSTOMER DRAWING			
3 PLACES		± 0.2		DRWN: MIKEDA01 2023/06/28					
2 PLACES		± 0.2		CHK'D: SAKIYAMA 2024/09/26					
1 PLACE		± 0.2		APPR: AIDA 2024/09/27					
0 PLACES		± 0.2		INITIAL REVISION:		DOCUMENT NUMBER			
				DRWN: AISHIKAWA 2019/04/02		2035590000-SD			
				APPR: KOMURAKAMI 2019/04/05		DOC TYPE		DOC PART	REVISION
						PSD		000	D
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION		DRAWING		SHEET NUMBER	
						A3-SIZE		1 OF 6	
				SERIES		MATERIAL NUMBER		CUSTOMER	
				203559		SEE SHEET 6			



2 TABLE 2

番号 NO.	部品 PART	材質 MATERIAL	
①	ウエハー WAFER	ポリアミド(PA), UL94V-0, 色 : SEE SHEET 6 POLYAMIDE(PA), UL94V-0, COLOR : SEE SHEET 6	
②	ソルダーピン SOLDER PIN	リン青銅 PHOSPHOR BRONZE	
		接点部 CONTACT AREA	金めっき : 0.76 MICRO-METER MIN. GOLD PLATING
		テール部 TAIL AREA	金めっき : 0.05 MICRO-METER MIN. GOLD PLATING
		下地めっき UNDER PLATING	ニッケルめっき : 1.27 MICRO-METER MIN. NICKEL
③	ネイル NAIL	黄銅 BRASS	
		テール部 TAIL AREA	錫めっき : 1.0 MICRO-METER MIN. MATTE TIN PLATING
		下地めっき UNDER PLATING	ニッケルめっき : 1.0 MICRO-METER MIN. NICKEL

14.0	17.0	15
13.0	16.0	14
12.0	15.0	13
11.0	14.0	12
10.0	13.0	11
9.0	12.0	10
8.0	11.0	9
7.0	10.0	8
6.0	9.0	7
5.0	8.0	6
B	A	極数 CIRCUIT SIZE

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																	
DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex										
mm	NTS																
GENERAL TOLERANCES (UNLESS SPECIFIED)				PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.76 MICRO-METER													
ANGULAR TOL ± 3.0 °																	
4 PLACES		± 0.2		EC NO: 794263			2023/06/28										
3 PLACES		± 0.2		DRWN: MIKEDA01													
2 PLACES		± 0.2		CHK'D: SAKIYAMA													
1 PLACE		± 0.2		APPR: AIDA			2024/09/26										
0 PLACES		± 0.2		INITIAL REVISION:			2024/09/27										
				DRWN: AISHIKAWA													
				APPR: KOMURAKAMI													
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				THIRD ANGLE PROJECTION		DRAWING		SERIES		DOCUMENT NUMBER		DOC TYPE		DOC PART		REVISION	
						A3-SIZE		203559		2035590000-SD		PSD		000		D	
										MATERIAL NUMBER		CUSTOMER				SHEET NUMBER	
										SEE SHEET 6						2 OF 6	

F

F

E

E

D

D

C

C

B

B

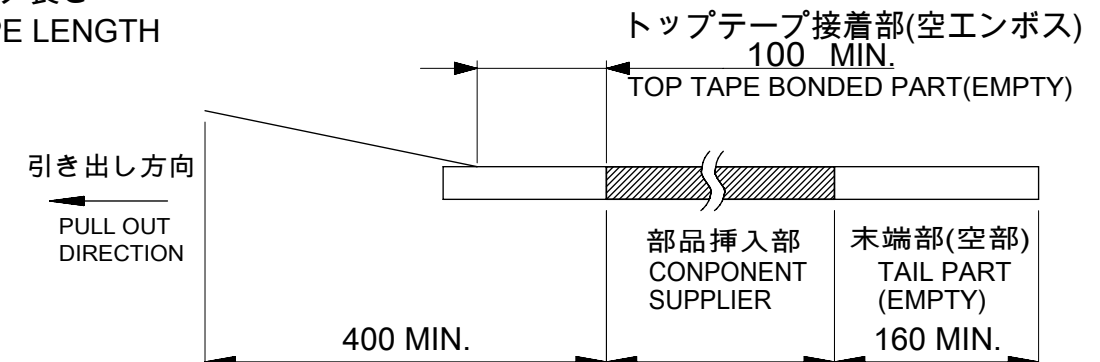
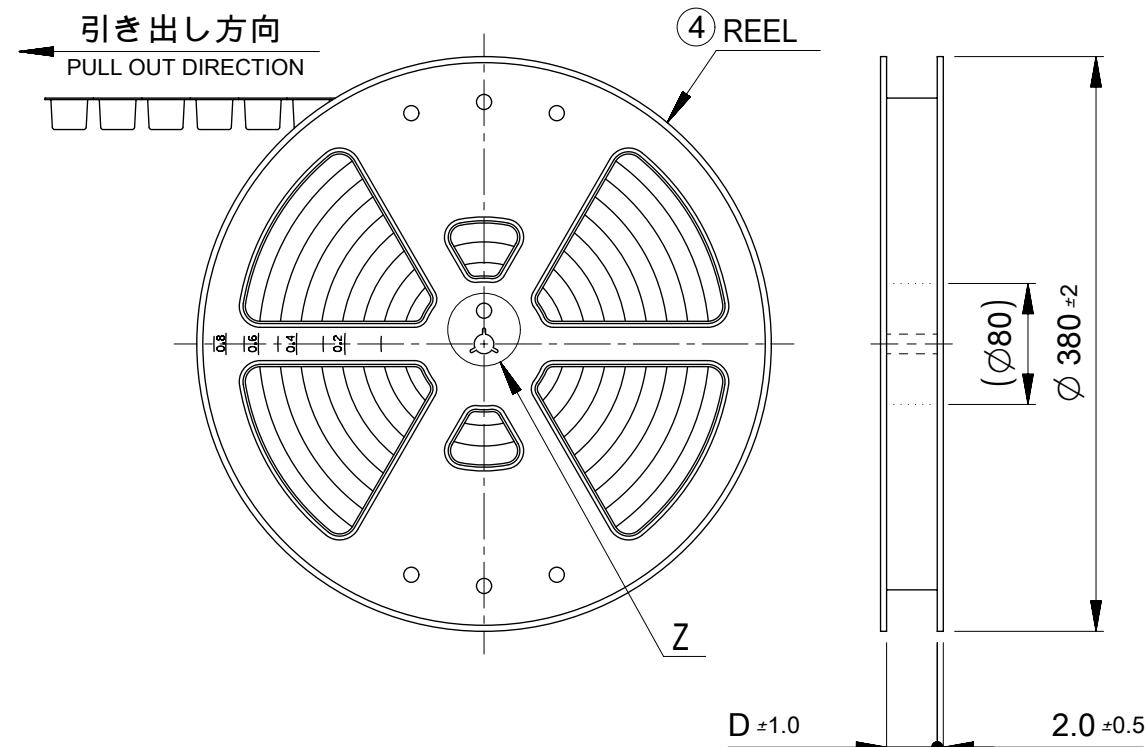
A

A

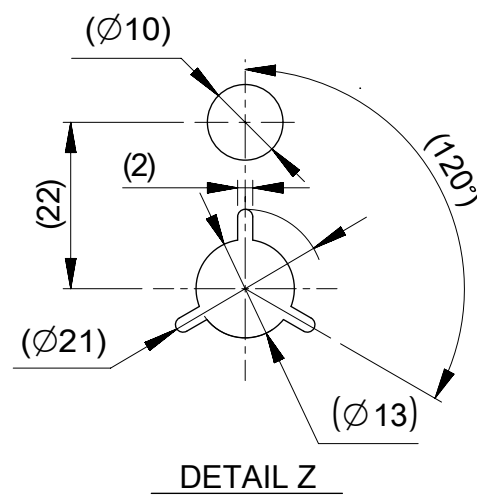
NOTES

10. 梱包数量
2-5 CIRCUIT: 1700個/リール
6-15 CIRCUIT: 1300個/リール
NUMBER OF CONNECTORS
2-5 CIRCUIT : 1700 PIECES/REEL
6-15 CIRCUIT : 1300 PIECES/REEL

- ## 11. リードテープ長さ LEAD TAPE LENGTH



- | | | |
|-----|---|------|
| 12. | トップテープの剥離強度はIEC60286-3に準拠。
TOP TAPE PEELING FORCE IS DEFINED BY IEC60286-3. | |
| 13. | 2~5極品は乾燥剤入り、ハイバリア梱包による納品となります。
2~5 CIRCUITS IS DELIVERED IN A HIGH BARRIER PACKAGING WITH DESICCANT. | |
| 14. | 梱包仕様書：2035599200 PS 200
PACKAGE SPECIFICATION: | 33.4 |
| 15. | 発注番号：SHEET 6 参照
ORDER No. : PLEASE REFER TO SHEET 6 FOR PRODUCT LIST. | |



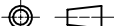
203559 - ** * *

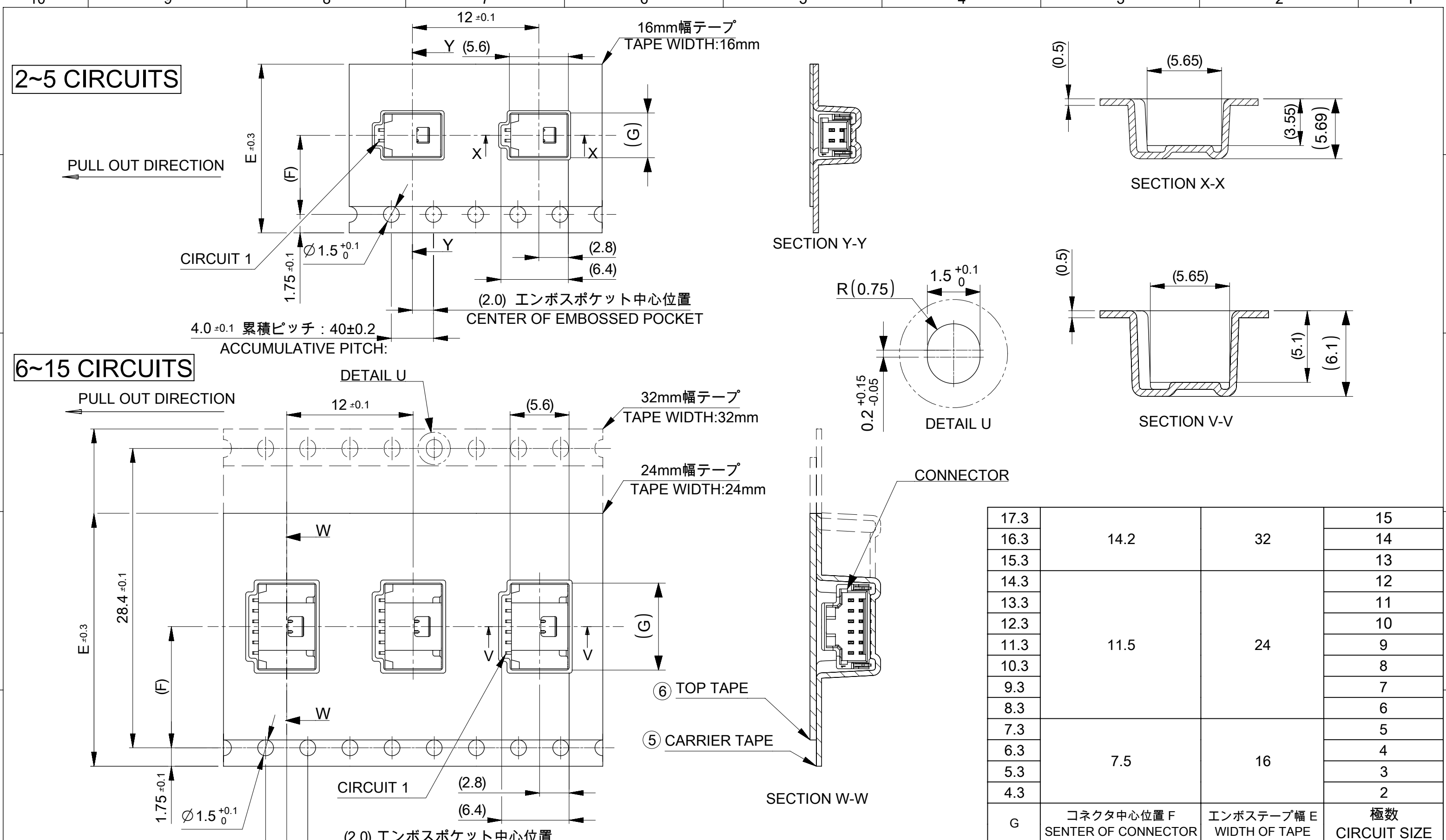
極数 CIRCUIT SIZE	ハウジングカラー HOUSING COLOR	製品識別番号 IDENTIFICATION NUMBER
	0:NATURAL(BEIGE)	7:EMBOSSD PACKAGE

33.4	15
	14
	13
25.4	12
	11
	10
	9
	8
	7
	6
17.5	5
	4
	3
	2
D	極数 CIRCUIT SIZE

番号 NO.	部品 PART	材質 MATERIAL
④	リール REEL	ポリスチレン(PS) <リサイクル材を含む> POLYSTYRENE(PS) <RECYCLE MATERIAL CONTAINED>

DOCUMENT STATUS	P1	RELEASE DATE	2024/09/27	10:55:26
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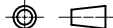
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION													
DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex						
mm		NTS											
GENERAL TOLERANCES (UNLESS SPECIFIED)							PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.76 MICRO-METER						
ANGULAR TOL ± 3.0 °													
4 PLACES		± 0.2											
3 PLACES		± 0.2					PRODUCT CUSTOMER DRAWING						
2 PLACES		± 0.2											
1 PLACE		± 0.2											
0 PLACES		± 0.2		DOCUMENT NUMBER			DOC TYPE		DOC PART	REVISION			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				EC NO: 794263 DRWN: MIKEDA01 2023/06/28 CHK'D: SAKIYAMA 2024/09/26 APPR: AIDA 2024/09/27			2035590000-SD			PSD		000	D
THIRD ANGLE PROJECTION		DRAWING		SERIES		MATERIAL NUMBER		CUSTOMER			SHEET NUMBER		
		A3-SIZE		203559		SEE SHEET 6					4 OF 6		



17.3	14.2	32	15
16.3			14
15.3			13
14.3	11.5	24	12
13.3			11
12.3			10
11.3			9
10.3			8
9.3			7
8.3	7.5	16	6
7.3			5
6.3			4
5.3			3
4.3			2
G	コネクタ中心位置 F SENER OF CONNECTOR	エンボステープ幅 E WIDTH OF TAPE	極数 CIRCUIT SIZE

番号 NO.	部品 PART	材質 MATERIAL
⑤	キャリアテープ CARRIER TAPE	ポリプロピレン(PP)、その他 POLYPROPYLENE(PP), etc
⑥	トップテープ TOP TAPE	ポリエチレン(PE)、その他 POLYETHYLENE(PE), etc

DOCUMENT STATUS	P1	RELEASE DATE	2024/09/27	10:55:26
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DIMENSION UNITS		SCALE		CURRENT REV DESC:			molex PICO-CLASP 1.0 W/B SINGLE ROW RA SMT INNER LOCK GOLD PLATING 0.76 MICRO-METER						
mm		NTS											
GENERAL TOLERANCES (UNLESS SPECIFIED)													
ANGULAR TOL		±		3.0 °		PRODUCT CUSTOMER DRAWING							
4 PLACES		±		0.2									
3 PLACES		±		0.2		DOCUMENT NUMBER 2035590000-SD							
2 PLACES		±		0.2									
1 PLACE		±		0.2									
0 PLACES		±		0.2									
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION		DRAWING		SERIES		MATERIAL NUMBER		CUSTOMER		SHEET NUMBER	
				A3-SIZE		203559		SEE SHEET 6				5 OF 6	
EC NO: 794263				DRWN: MIKEDA01		2023/06/28							
CHK'D: SAKIYAMA				APPR: AIDA		2024/09/26							
INITIAL REVISION:				DRWN: AISHIKAWA		2019/04/02							
APPR: KOMURAKAMI				2019/04/05									

10	9	8	7	6	5	4	3	2	1